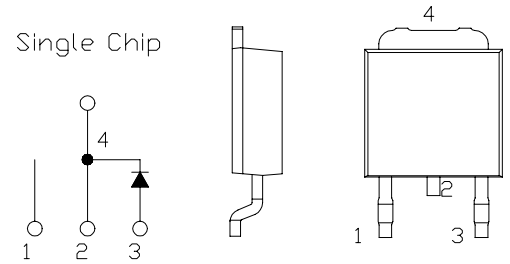


FRD Type : EA31FS4-F

OUTLINE DRAWING

FEATURES

- * TO-252AA Case, Surface Mounting Device
- * Packaged in 16mm Tape and Reel
- * Ultra – Fast Recovery
- * Low Forward Voltage drop
- * Low Power Loss
- * High Surge Capability
- * 200 Volts thru 600 Volts Types Available



Maximum Ratings

Approx Net Weight:0.30g

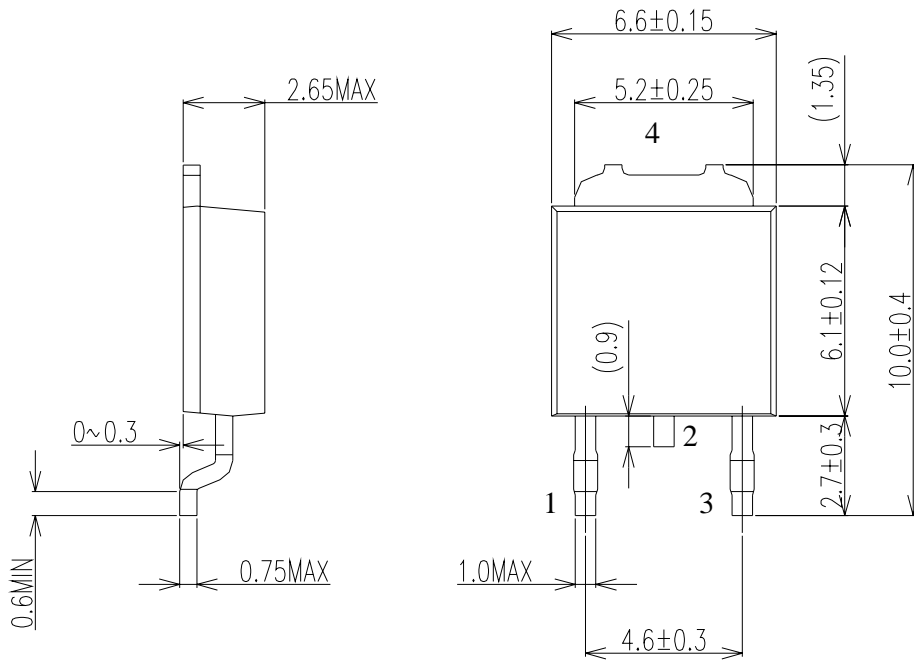
Rating		Symbol	EA31FS4-F			Unit
Repetitive Peak Reverse Voltage		V_{RRM}	400			V
Non-repetitiv Peak Reverse Voltage		V_{RSM}	440			
Average Rectified Output Current	P.C.Board mounted *	I_O	1.4	$T_a=34^{\circ}C$	50Hz Half Sine Wave Resistive Load	A
	-		3.0	$T_c=125^{\circ}C$		
RMS Forward Current		$I_{F(RMS)}$	4.71			A
Surge Forward Current		I_{FSM}	45	50Hz Half Sine Wave, 1cycle, Non-repetitive		A
Operating Junction Temperature Range		T_{jw}	- 40 to + 150			$^{\circ}C$
Storage Temperature Range		T_{stg}	- 40 to + 150			$^{\circ}C$

Electrical • Thermal Characteristics

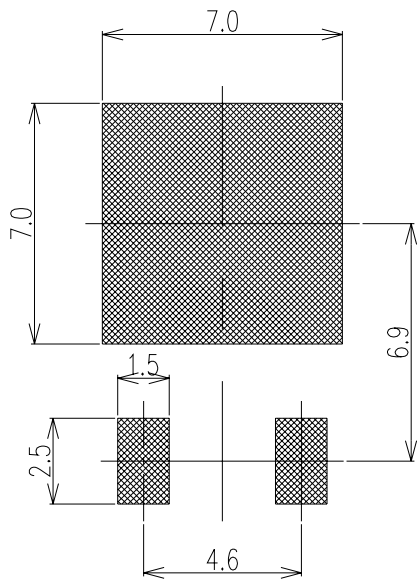
Characteristics		Symbol	Conditions	Min	Typ	Max	Unit
Peak Reverse Current		I_{RM}	$T_j=25^{\circ}C, V_{RM}=V_{RRM}$ per Arm	-	-	20	μA
Peak Forward Voltage		V_{FM}	$T_j=25^{\circ}C, I_{FM}= 3 A$ per Arm	-	-	1.25	V
Reverse Recovery Time		t_{rr}	$I_{FM}= 3 A,$ $-di/dt= 50 A/\mu s, T_a= 25^{\circ}C$	-	-	30	ns
Thermal Resistance	Junction to Ambient	$R_{th(j-a)}$	P.C.Board mounted *	-	-	80	$^{\circ}C/W$
	Junction to Case	$R_{th(j-c)}$	-	-	-	6	$^{\circ}C/W$

* Print Land = 20x20 mm

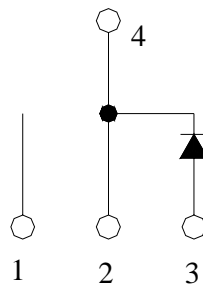
EA31FS4-F OUTLINE DRAWING (Dimensions in mm)



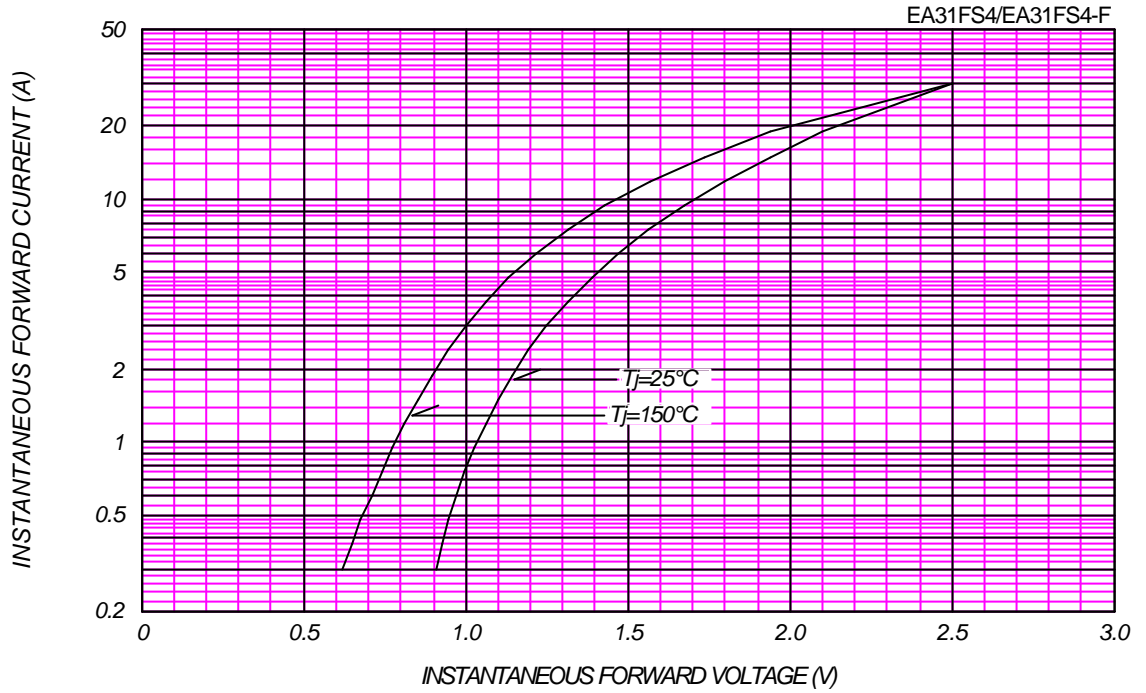
Soldering PAD



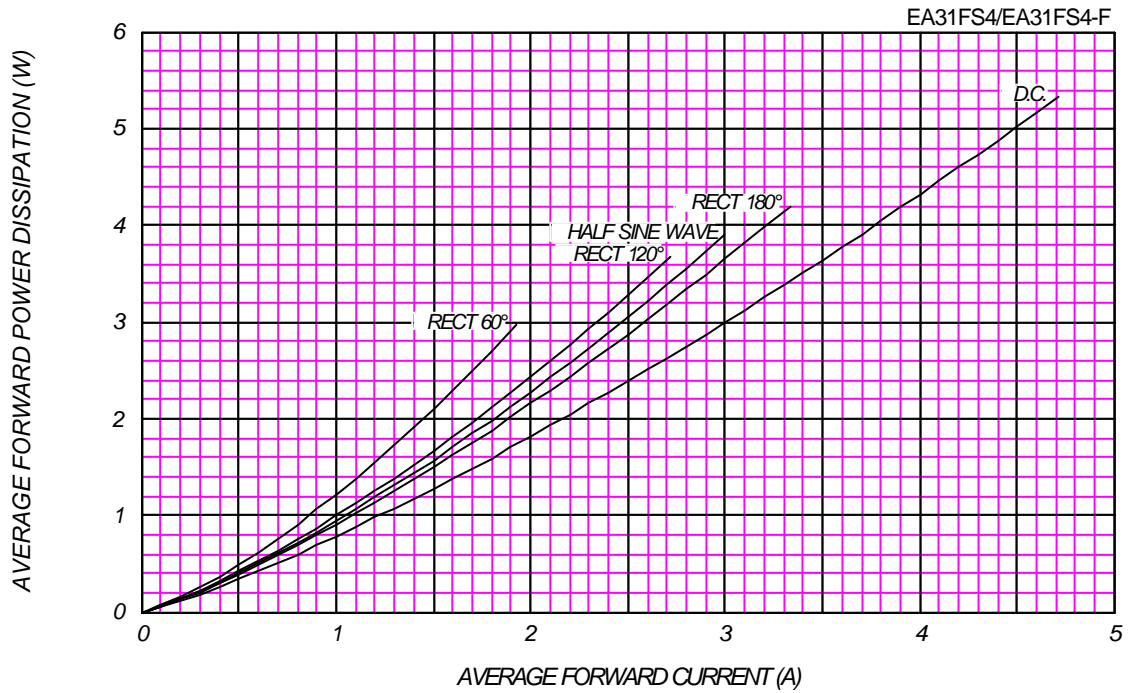
Single

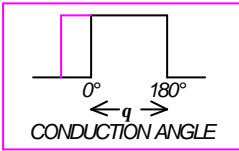


FORWARD CURRENT VS. VOLTAGE

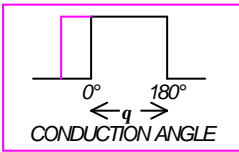
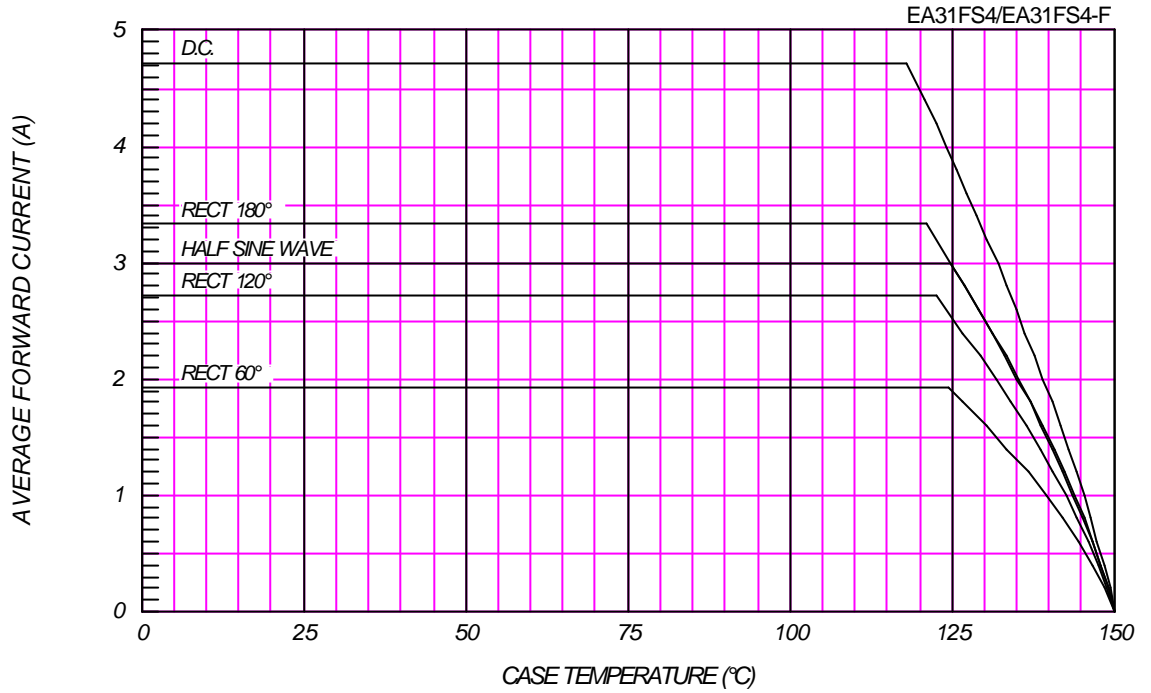


AVERAGE FORWARD POWER DISSIPATION



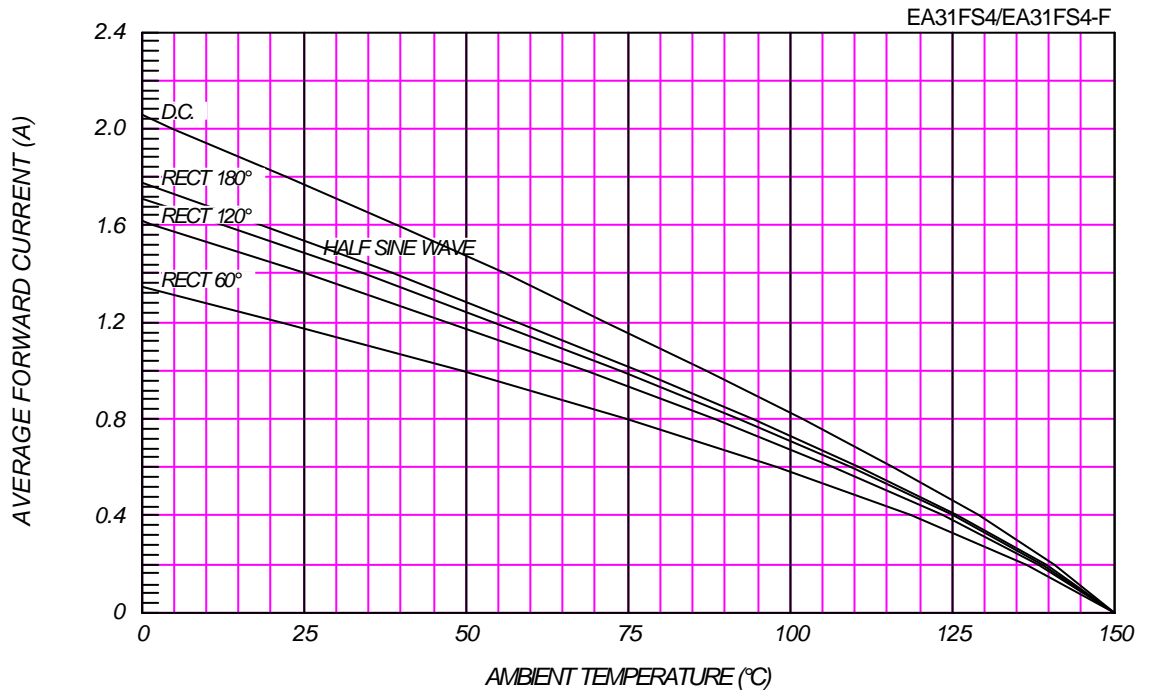


AVERAGE FORWARD CURRENT VS. CASE TEMPERATURE



AVERAGE FORWARD CURRENT VS. AMBIENT TEMPERATURE

P.C. Board mounted (Print land=20x20mm)



SURGE CURRENT RATINGS

f=50Hz, Half Sine Wave, Non-Repetitive, No Load

EA31FS4/EA31FS4-F

